

October 1995 Revised May 2003

NC7S00

TinyLogic® HS 2-Input NAND Gate

General Description

The NC7S00 is a single 2-Input high performance CMOS NAND Gate. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad V_{CC} range. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. Three stages of gain between inputs and output assures high noise immunity and reduced sensitivity to input edge rate.

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High speed: t_{PD} 3.5 ns typ
- \blacksquare Low Quiescent Power: $I_{CC} < 1~\mu\text{A}$
- Balanced Output Drive: 2 mA I_{OL}, -2 mA I_{OH}
- Broad V_{CC} Operating Range: 2V–6V
- Balanced Propagation Delays
- Specified for 3V operation

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7S00M5X	MA05B	7S00	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7S00P5X	MAA05A	S00	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7S00L6X	MAC06A	A3	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol



Pin Descriptions

Pin Names	Description
A, B	Input
Y	Output
NC	No Connect

Function Table

$$Y = \overline{AB}$$

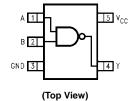
Inp	Output			
Α	A B			
L	L	Н		
L	Н	Н		
Н	L	Н		
Н	Н	L		

H = HIGH Logic Level

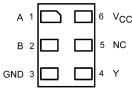
L = LOW Logic Level

Connection Diagrams

Pin Assignments for SC70 and SOT23



Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\tiny TM} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions (Note 2)

SC70-5

150°C

260°C

Supply Voltage (V _{CC})	-0.5V to +7.0V
DC Input Diode Current (I _{IK})	
$@V_{IN} \le -0.5V$	−20 mA
$@V_{IN} \ge V_{CC} + 0.5V$	+20 mA
DC Input Voltage (V _{IN})	$-0.5V$ to $V_{CC} + 0.5V$
DC Output Diode Current (I _{OK})	
$@V_{OUT} < -0.5V$	−20 mA

DC Output Source

or Sink Current (I_{OUT}) $\pm 12.5 \text{ mA}$

DC V_{CC} or Ground Current

per Output Pin (I_{CC} or I_{GND}) ± 25 mA Storage Temperature (T_{STG}) -65° C to $+150^{\circ}$ C

Junction Temperature (T_J) Lead Temperature (T_L);

(Soldering, 10 seconds)

Power Dissipation (PD) @ +85°C

SOT23-5 200 mW SC70-5 150 mW

Supply Voltage (V_{CC}) 2.0V-6.0V Input Voltage (V_{IN}) $0V-V_{CC}$ $0V-V_{CC}$ Output Voltage (V_{OUT}) Operating Temperature (T_A) $-40^{\circ}C$ to $+85^{\circ}C$ Input Rise and Fall Time (t_r, t_f) V_{CC} @ 2.0V 0-1000 ns V_{CC} @ 3.0V 0-750 ns V_{CC} @ 4.5V 0-500 ns V_{CC} @ 6.0V 0-400 ns Thermal Resistance (θ_{JA}) SOT23-5 300°C/W

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

425°C/W

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	v _{cc}		T _A = +25°C	;	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions
Symbol		(V)	Min	Тур	Max	Min	Max	Oilles	Conditions
V _{IH}	HIGH Level Input Voltage	2.0	1.50			1.50		V	
		3.0 - 6.0	0.7 V _{CC}			0.7V _{CC}		v	
V _{IL}	LOW Level Input Voltage	2.0			0.50		0.50	V	
		3.0 - 6.0			$0.3V_{CC}$		$0.3\mathrm{V}_{\mathrm{CC}}$	v	
V _{OH}	HIGH Level Output Voltage	2.0	1.90	2.0		1.90			
		3.0	2.90	3.0		2.90		V	$I_{OH} = -20 \mu A$ $V_{IN} = V_{IL}$
		4.5	4.40	4.5		4.40		V	$V_{IN} = V_{IL}$
		6.0	5.90	6.0		5.90			
									V _{IN} = V _{IL}
		3.0	2.68	2.85		2.63		V	$I_{OH} = -1.3 \text{ mA}$
		4.5	4.18	4.35		4.13		v	$I_{OH} = -2 \text{ mA}$
		6.0	5.68	5.85		5.63			$I_{OH} = -2.6 \text{ mA}$
V _{OL}	LOW Level Output Voltage	2.0		0.0	0.10		0.10		
		3.0		0.0	0.10		0.10	V	$I_{OL} = 20 \mu A$ $V_{IN} = V_{IH}$
		4.5		0.0	0.10		0.10	v	$V_{IN} = V_{IH}$
		6.0		0.0	0.10		0.10		
									$V_{IN} = V_{IH}$
		3.0		0.1	0.26		0.33	V	$I_{OL} = 1.3 \text{ mA}$
		4.5		0.1	0.26		0.33	v	$I_{OL} = 2 \text{ mA}$
		6.0		0.1	0.26		0.33		I _{OL} = 2.6 mA
I _{IN}	Input Leakage Current	6.0			±0.1		±1.0	μΑ	$V_{IN} = V_{CC}$, GND
I _{CC}	Quiescent Supply Current	6.0			1.0		10.0	μΑ	$V_{IN} = V_{CC}$, GND

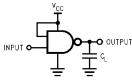
AC Electrical Characteristics

Symbol	Parameter	v _{cc}		$T_A = +25^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
		(V)	Min	Тур	Max	Min	Max	Omis	Conditions	Number
t _{PLH} ,	Propagation Delay	5.0		3.5	15			ns	$C_{L} = 15 \text{ pF}$	
t _{PHL}	t _{PHL}			19	100		125			1
		3.0		10.5	27		35	ns	C _L = 50 pF	Figures 1, 3
		4.5		7.5	20		25			
		6.0		6.5	17		21			
t _{TLH} ,	Output Transition Time	5.0		3.0	10			ns	C _L = 15 pF	
t _{THL}		2.0		25	125		155			1
		3.0		16	35		45	no	0 50 - 5	Figures 1, 3
		4.5		11	25		31	ns	$C_L = 50 pF$	1, 3
		6.0		9	21		26			
C _{IN}	Input Capacitance	Open		2	10		10	pF		
C _{PD}	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression:

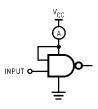
I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).

AC Loading and Waveforms



 C_L includes load and stray capacitance Input PRR = 1.0 MHz, $t_{\rm w}$ = 500 ns

FIGURE 1. AC Test Circuit



Input = AC Waveform;

PRR = variable; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

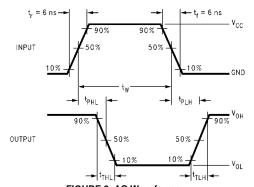


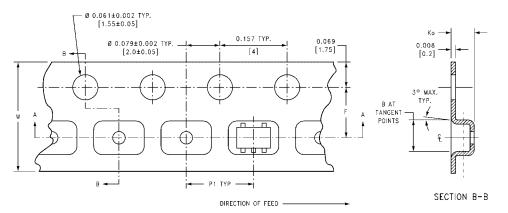
FIGURE 3. AC Waveforms

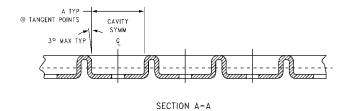
Tape and Reel Specification

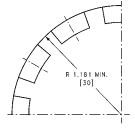
TAPE FORMAT for SC70 and SOT23

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
M5X, P5X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)







BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ±0.004	0.053 ±0.004	0.157	0.315 ±0.004
		(2.35)	(2.45)	(3.5 ±0.10)	(1.35 ±0.10)	(4)	(8 ±0.1)
SOT23-5	9 mm	0.130	0.130	0.138 ±0.002	0.055 ±0.004	0.157	0.315 ±0.012
	8 mm	(3.3)	(3.3)	(3.5 ±0.05)	(1.4 ±0.11)	(4)	(8 ±0.3)

Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 ^{+0.30} -0.10 3.50±0.05 1.15±0.05 **-** → В◄ -ø 0.50 ±0.05 SECTION B-B DIRECTION OF FEED SCALE:10X 0.254±0.020 Г 0.70±0.05 SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X **DETAIL X** SCALE: 3X Tape Α В С D N W1 W2 W3 Size 2.165 0.331 +0.059/-0.000 0.567 W1 +0.078/-0.039 0.059 0.512 0.795 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 +1.50/-0.00) (14.40)(W1 +2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 2.00±0.20 0.65 1.9 B- 1.25±0.10 2.10±0.10 0.4 min -0.20 ^{+0.10} -0.05 0.25 LAND PATTERN RECOMMENDATION ♦ max 0.1 **⊗** SEE DETAIL A 0.9±.10 0.95±0.15 max 0.1 R0.14 GAGE PLANE R0.10 0.20 0.45 0.10 - 0.425 NOMINAL DETAIL A

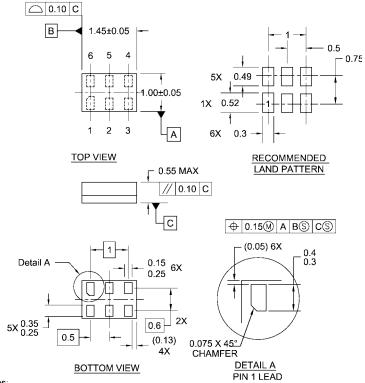
NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com